

## PRODUCT DATASHEET Rose series

last update 26/2/2015

## **DETAILS**

Family

Ledil Oy

Salorankatu 10

24240 SALO, Finland

Product Number FA10668\_CXP-RS

Rose

Type Assembly
Color black
Diameter 21,6 + 21,6 mm
Height 13,15 mm
Style square
Optic Material PC

Holder Material PC
Fastening tape
Status ready
ROHS Comliant Yes

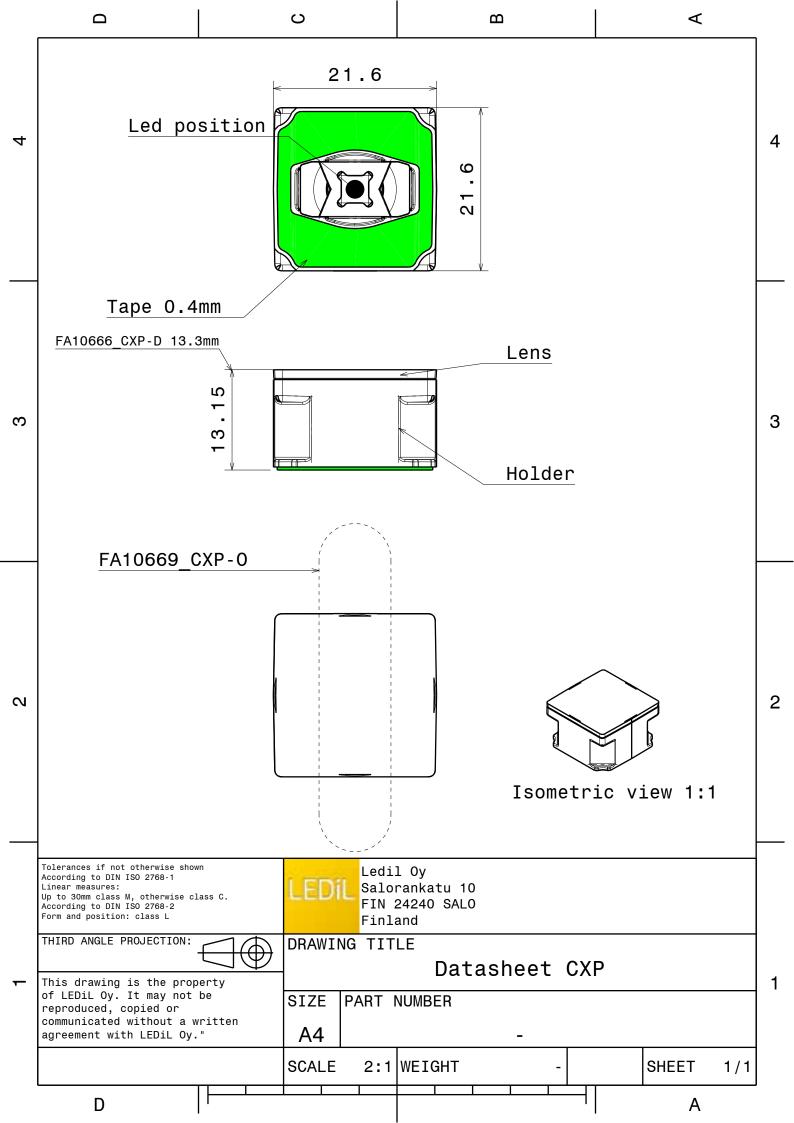
**Date Updated** 20/03/2015

## **OPTICAL PROPERTIES**

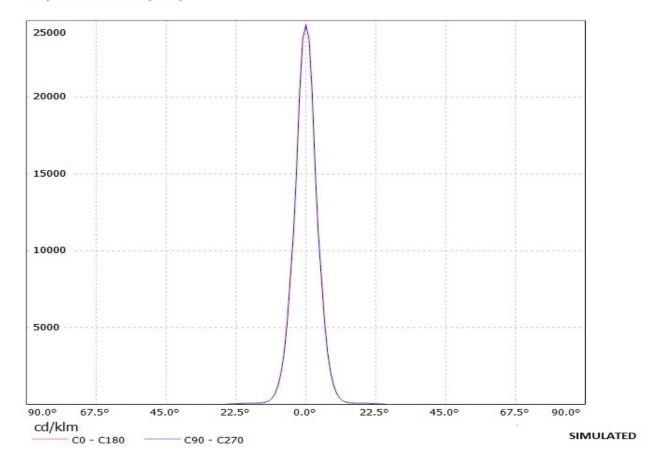
	Viewing	Light	Effi-		
LED	Angle	Beam	ciency	cd/lm	Connector
XP-G2	sim: 11	Real spot	sim: 87 %	sim: 20.300	)-
XP-E	7 deg	Real spot	86 %	24.770	-
Z5	7 deg	Real spot	83 %	-	-
XP-G	11 deg	Real spot	85 %	15.870	-
XP-L	16 deg	Real spot	80 %	8.700	-



http://www.ledil.com email: ledil@ledil.com FAX: +358-2-733 8001

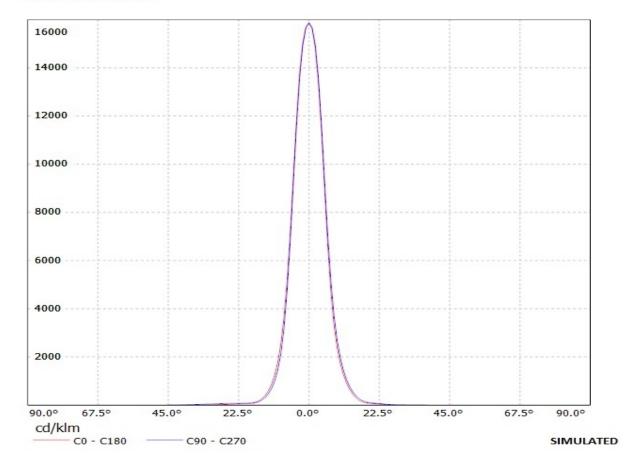


Luminaire: Ledil Oy FA10668\_CXP-RS FA10668\_CXP-RS Lamps: 1 x Cree XP-E (white)

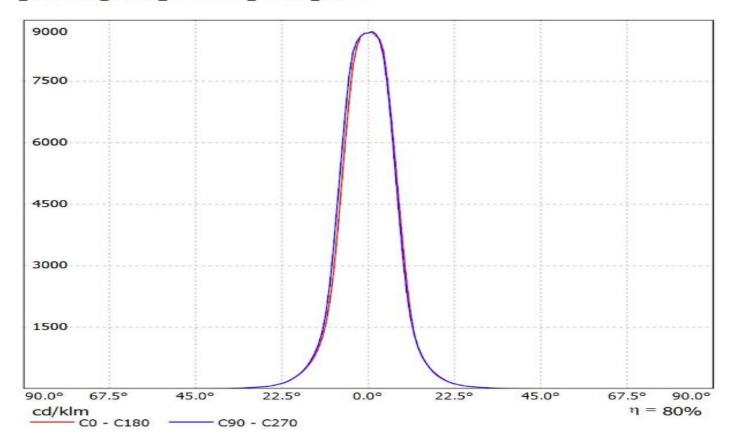


Luminaire: Ledil FA10668\_CXP-G-RS FA10668\_CXP-G-RS

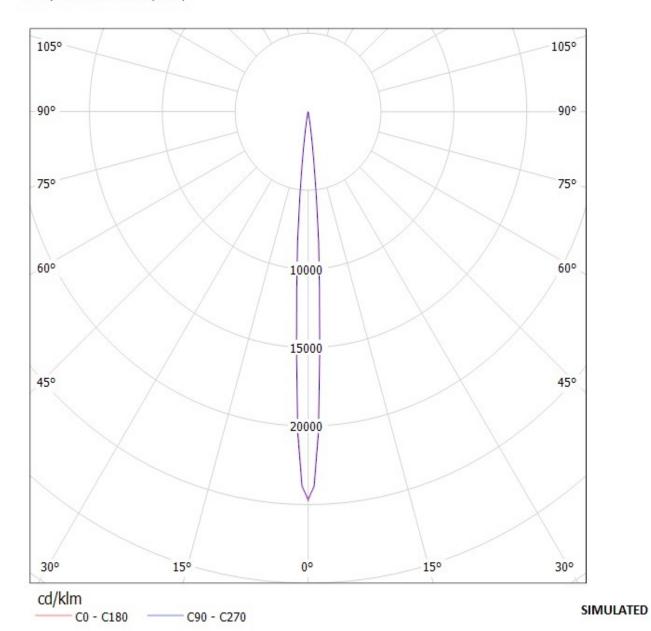
Lamps: 1 x LED Module



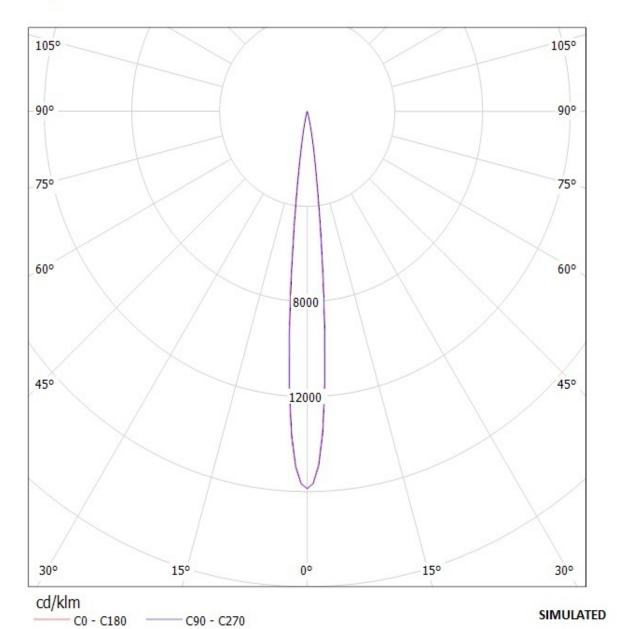
Luminaire: Ledil FA10668\_CXP-RS\_(XP-L)
Lamps: 1 x CREE\_XP-L\_(XPLAWT-0-7A3-U50-0H-0001)
\_107.852Im@250mA\_CCT=3185K\_P=0.7W\_I=0.25A



Luminaire: Ledil Oy FA10668\_CXP-RS FA10668\_CXP-RS Lamps: 1 x Cree XP-E (white)

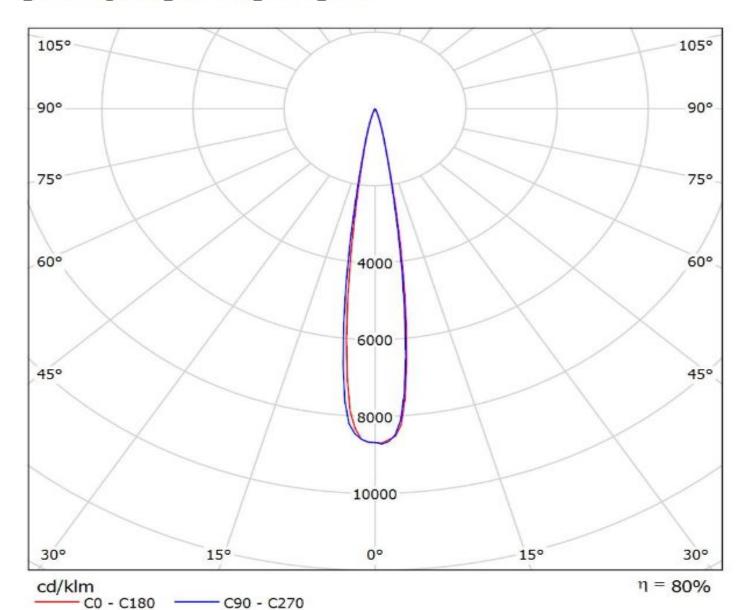


Luminaire: Ledil FA10668\_CXP-G-RS FA10668\_CXP-G-RS Lamps: 1 x LED Module



Luminaire: Ledil FA10668 CXP-RS (XP-L)

Lamps: 1 x CREE\_XP-L\_(XPLAWT-0-7A3-U50-0H-0001) \_107.852Im@250mA\_CCT=3185K\_P=0.7W\_I=0.25A



NOTE: The typical divergence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.

## **GENERAL INFORMATION**

- Product series especially designed & optimized for series of LEDs.
- Special care taken to make light distribution as uniform as possible.
- Fastening to heat sink with a PU foam adhesive tape of automotive grade. Please find fastening details by clicking link: http://www.ledil.com/datasheets/DataSheet\_TAPE.pdf
- NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the tape.
- NOTE 2: Assembly to the surface must be made straight, so the tape bonds constant and balanced with fastening surface. Slanted assembly might cause unbalanced bond to the surface. All surfaces where tape is applied must be clean, dry and free from grease and dirt.

If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer - this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.